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(12) **United States Design Patent**  
**Chen et al.**

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(54) **HEAT-DISSIPATING DEVICE FOR MEMORY**

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(\*\*) Term: **14 Years**

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(51) **LOC (9) Cl.** ..... **13-03**

(52) **U.S. Cl.** ..... **D13/179**

(58) **Field of Classification Search** ..... D13/179;  
165/80.2, 80.3, 104.33, 151, 122, 185; 361/704,  
361/709

See application file for complete search history.

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(57) **CLAIM**

The ornamental design for an heat-dissipating device for memory, as shown and described.

**DESCRIPTION**

FIG. 1 is a perspective view of an heat-dissipating device for memory showing my new design;

FIG. 2 is a front elevation view thereof;

FIG. 3 is a rear elevation view thereof;

FIG. 4 is a left side elevation view thereof;

FIG. 5 is a right side elevation view thereof;

FIG. 6 is a top plan view thereof;

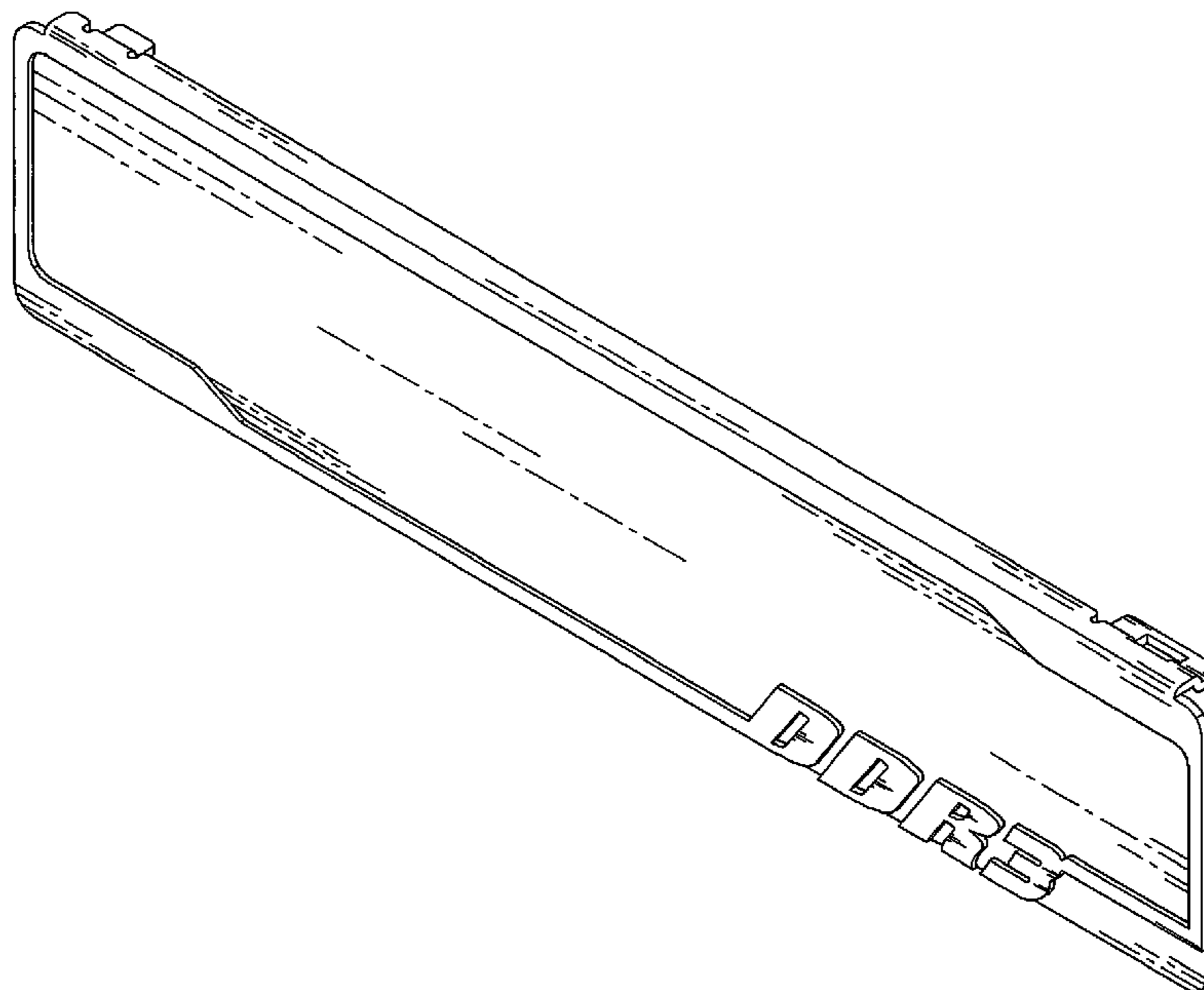
FIG. 7 is a bottom plan view thereof;

FIG. 8 is an application diagram thereof; and,

FIG. 9 is an another application diagram thereof.

The broken line showing of the environment is for illustrative purposes only and forms no part of the claimed design.

**1 Claim, 7 Drawing Sheets**



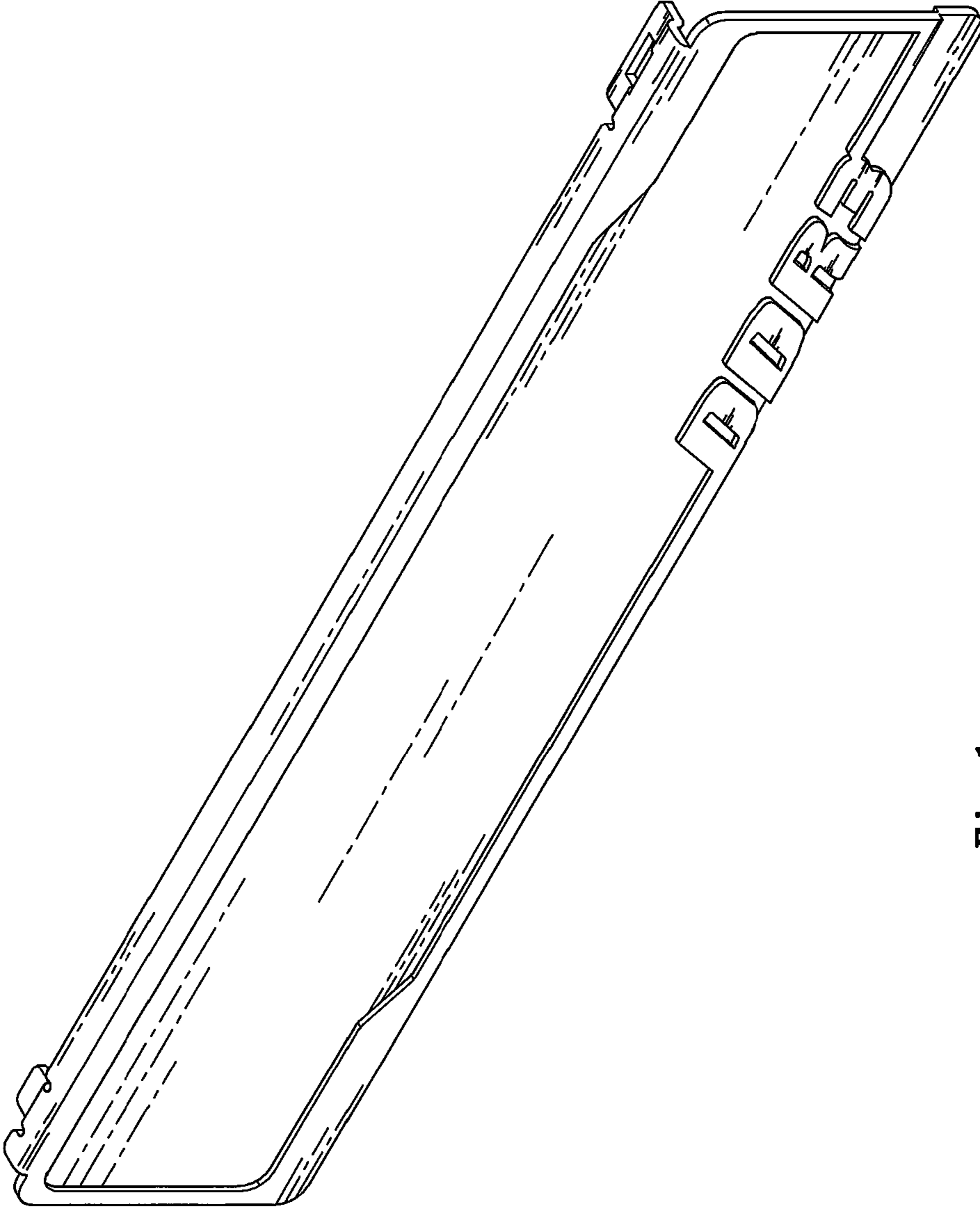


Fig. 1

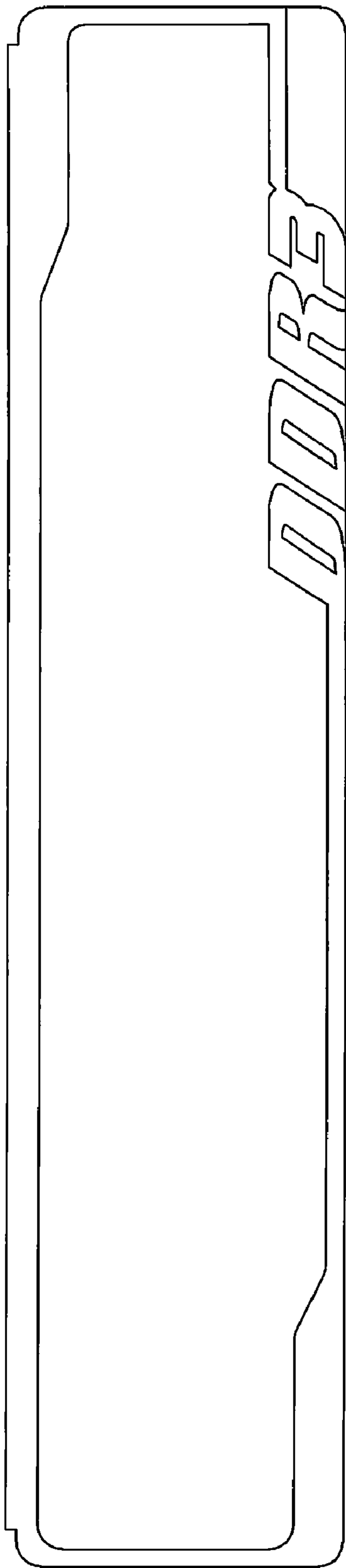


Fig. 2

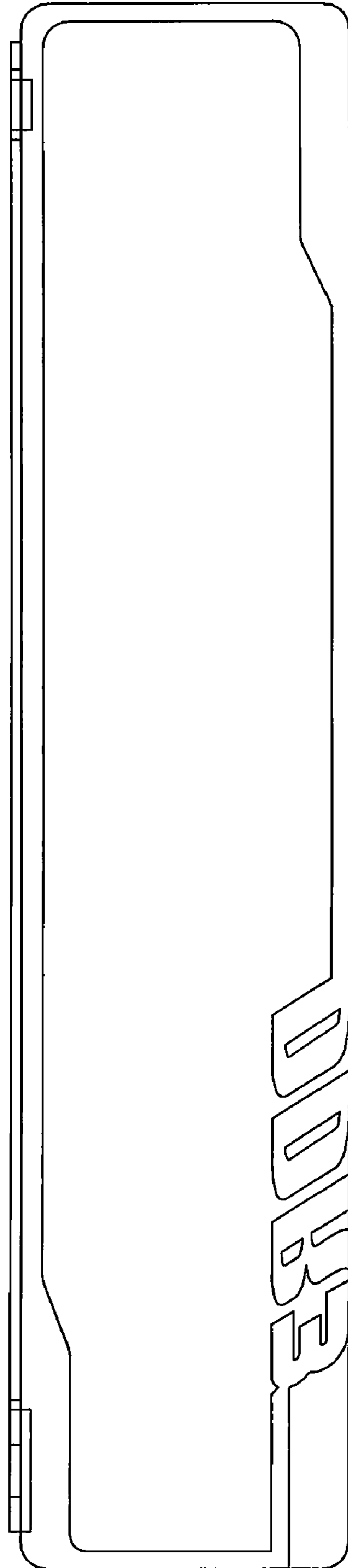


Fig. 3

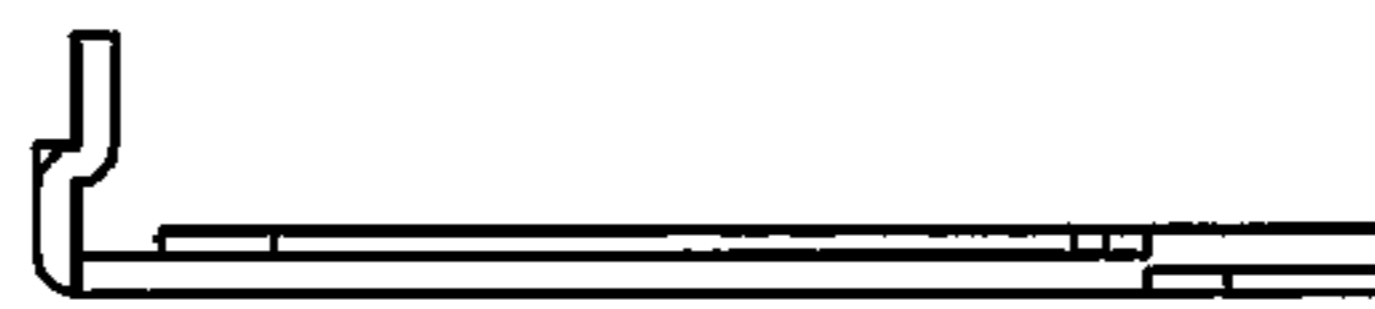


Fig. 5

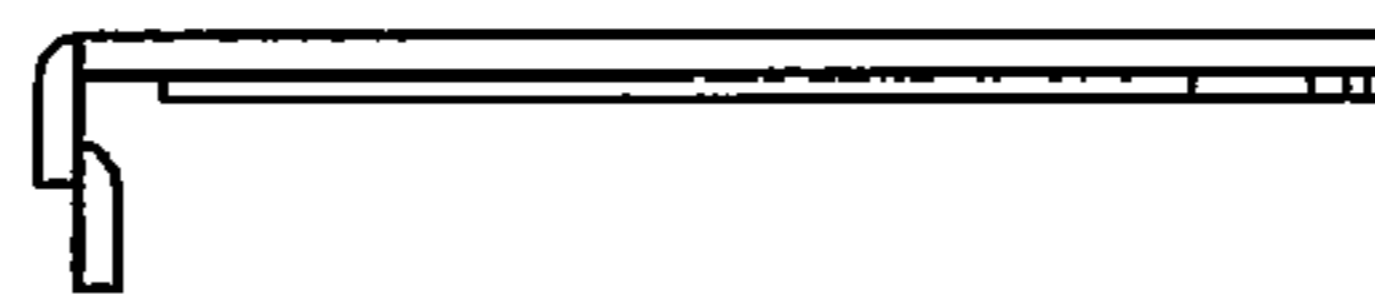


Fig. 4



Fig. 6

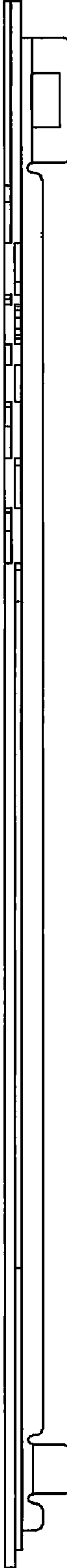


Fig. 7

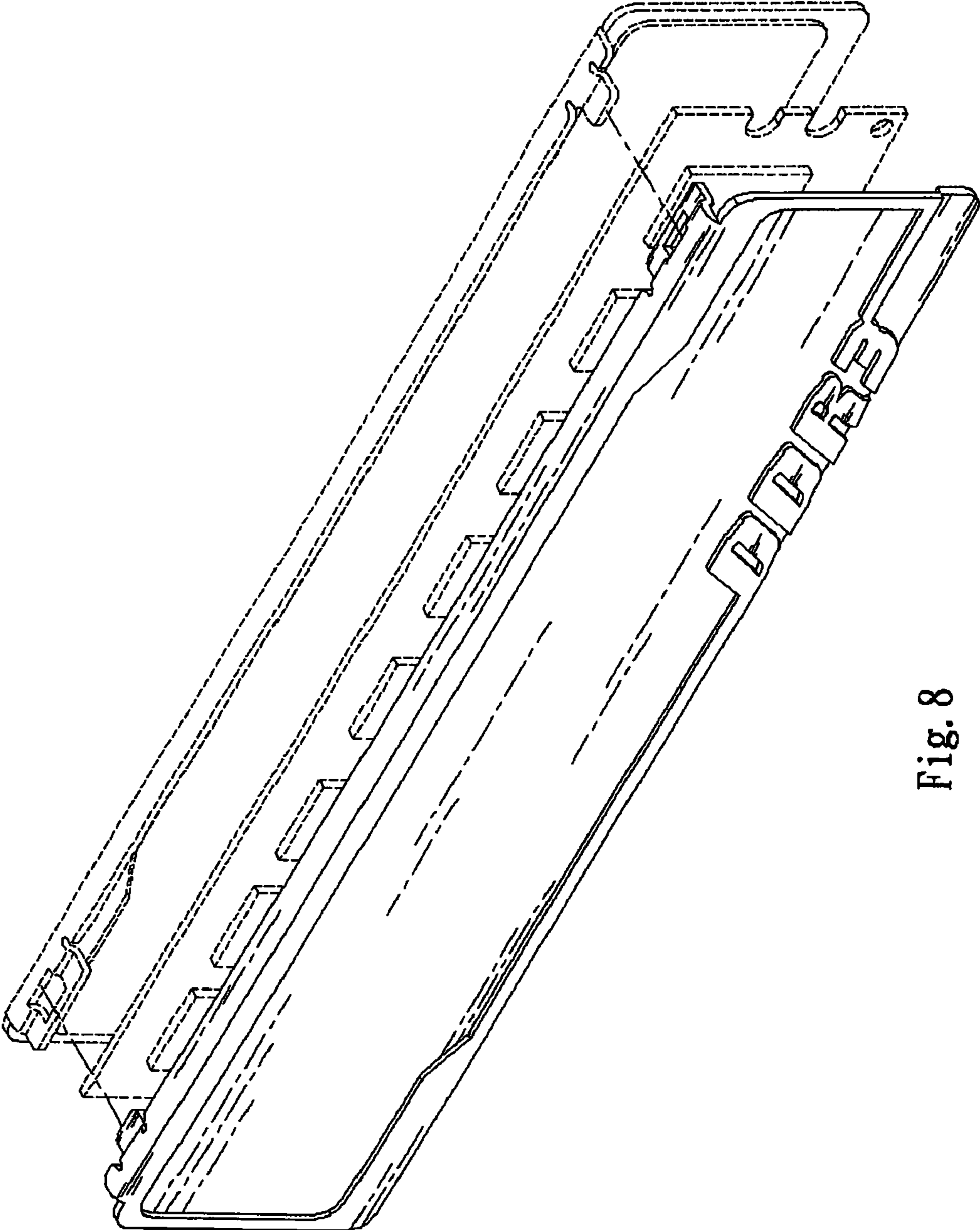


Fig. 8



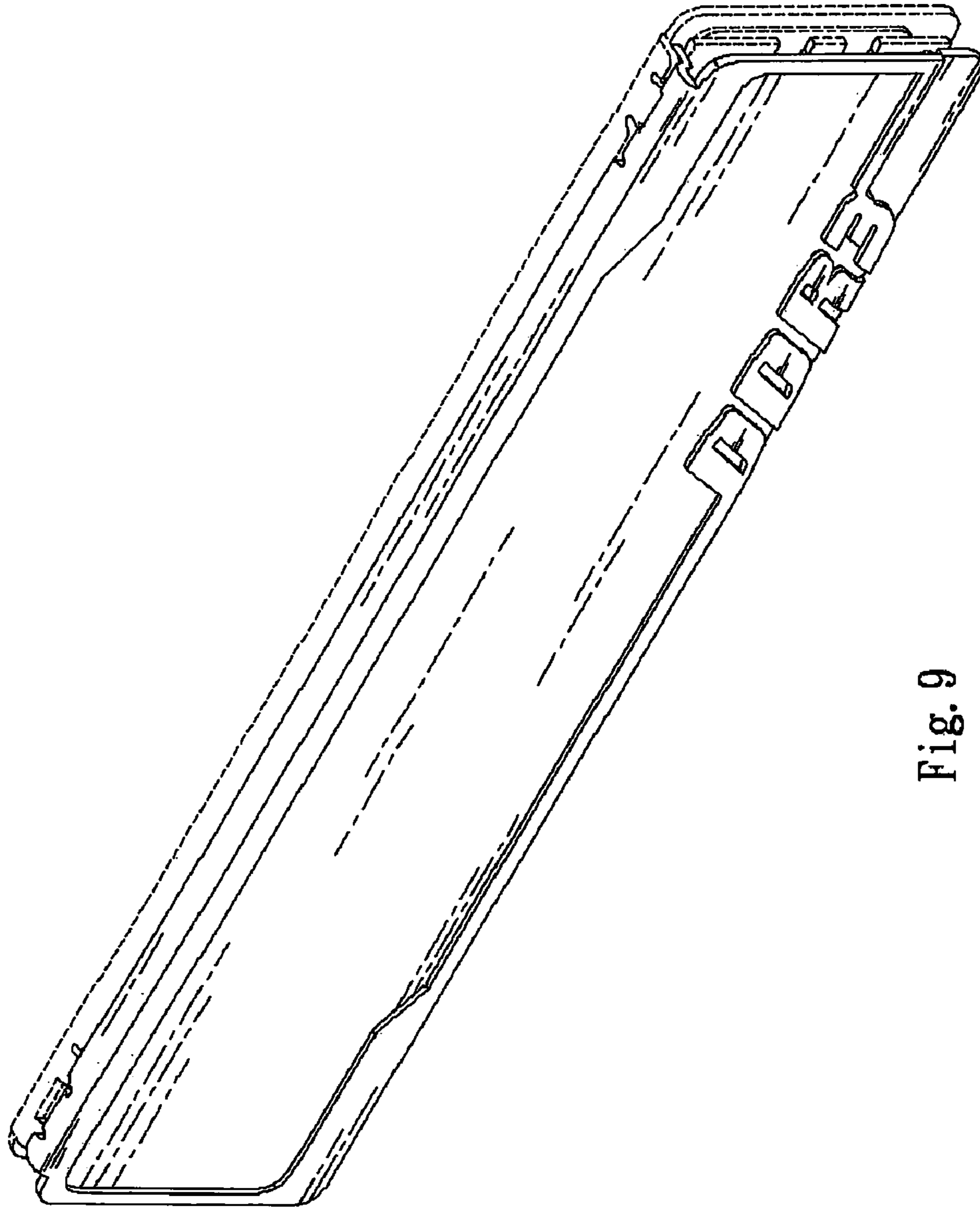


Fig. 9